IPC ASSOCIATION CONNE LECTRONICS INDUS	Material Comp © Copyright 2005. I international and Par	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.								
52-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				e * Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					ials and Mfg Information			
upplier Info	rmation						·							
Company name* Company			Company uni	ny unique ID			Unique ID Authority			Respon	Response Date*			
semi											2025-07-18			
Contact Name Ti				Title - Contact			Phone - Contact*			Email -	Email - Contact*			
roduct-Env-Sto	ewards		Product Envi	Product Enviro Compliance			NA			Produc	Product-Env-Stewards@onsemi.com			
Authorized Representative*				Title - Representative			Phone - Representative*			Email -	Email - Representative*			
Product-Env-Stewards Pro				Product Enviro Compliance			NA			Produc	Product-Env-Stewards@onsemi.com			
Requ	ester Item Number	Mfr Iten	n Number	Mfr Item Name		E	ffective Date	Version	Manufacturing Site		Weight*	UOM	Unit Type	
		NXH80' G	T120L3Q0S3T	PIM Generation3 Q0 TNPC (Solder Pin, T	Pack 1200V, 80A IM)	A 20	025-07-18		CNG		24200.0	mg	Each	
[anufacturi	ng Proccess Informa	tion												
Termi	Terminal Plating / Grid Array Material		Terminal Base Alloy J-STD-020 M		ΓD-020 MSL Rat	ting	Peak Process Body Temperature Max Time at Pea			ak Tempera	ture Numbe	er of Reflow Cyc	eles	
Matte Tin (Sn) - annealed		CU Alloy NA				0	C	30	secon	nds 3				
omments														

RoHS Material Composition Declaration			Declaration Type *	Detail	ed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		ium (Cr6+), Polybrominated Biphenyls (PB)	erial for Cadmium and quantity limit of 0.1% b B), Polybrominated Diphenyl Ethers (PBDE), a							
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's St										
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted					
Exemption: If the declared item does not applicable exemptions.	contain RoHS restricted substances per t	he definition above except for defined Rol	IS exemptions, then select the corresponding	response in the R	oHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the					

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

<b>Homogeneous Material</b>	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Case	10300.0	mg	Supplier	Fiber Glass (SiO2)	65997-17-3		3090.0002	mg
			Supplier	Poly(ButyleneTerephthalate)	30965-26-5		2884	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		360.5	mg
			Supplier	PBT	26062-94-2		2884	mg
			-	Carbonic Dichloride	94334-64-2		1081.5	mg
DBC	6000.0	mg	Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		2502	mg
			В	Nickel (Ni)	7440-02-0		12	mg
			Supplier	Copper (Cu)	7440-50-8		3485.9998	mg
Die	110.0	mg	Supplier	Silicon (Si)	7440-21-3		110	mg
Die Attach	500.0	mg	Supplier	Silver (Ag)	7440-22-4		30	mg
			Supplier	Tin (Sn)	7440-31-5		470	mg
Glue	150.0	mg	Supplier	2,3-epoxypropyl-trimethoxysilan	2530-83-8		15	mg
			Supplier	Miscellaneous	Trade Secret		15	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		120	mg
Interconnect	830.0	mg	Supplier	Zinc Monoxide (ZnO)	1314-13-2		83	mg
			Supplier	Silicon (Si)	7440-21-3		249	mg
			Supplier	Aluminum (Al)	7429-90-5		498	mg
NTC	10.0	mg	Supplier	Silver (Ag)	7440-22-4		0.0979	mg
			Supplier	Tin (Sn)	7440-31-5		0.02	mg
			Supplier	Nickel Oxide (NiO)	1313-99-1		3.9169	mg
			Supplier	Palladium (Pd)	7440-05-3		0.0999	mg
			В	Nickel (Ni)	7440-02-0		0.01	mg
			Supplier	Cobalt Oxide (Co3O4)	1308-06-1		0.3997	mg
			Supplier	Manganese Tetraoxide (Mn3O4)	1317-35-7		5.4556	mg
Pressfit Terminal	2100.0	00.0 mg	В	Nickel (Ni)	7440-02-0		2.1	mg
			Supplier	Copper (Cu)	7440-50-8		2097.8999	mg
Protection coat	2810.0	mg	Supplier	Toulene	108-88-3		1.405	mg
			Supplier	Dimethyl Siloxane	68083-19-2		2808.595	mg
Wire Bond - Al	1390.0	mg	Supplier	Aluminum (Al)	7429-90-5		1390	mg